IPC-CC-830C 2018 - December

Qualification and Performance of Electrical Insulating Compound for Printed Wiring Assemblies

Supersedes IPC-CC-830B - Amendment 1 September 2008

An international standard developed by IPC

Association Connecting Electronics Industries



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- Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

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- Increase time-to-market
- Keep people out
- Increase cycle time
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IPC-CC-830C

Qualification and Performance of Electrical Insulating Compound for Printed Wiring Assemblies

Developed by the Conformal Coating Task Group (5-33a) of the Cleaning and Coating Committee (5-30)

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